TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π - MOSIV)

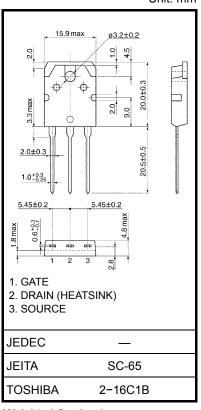
2SK3878

Switching Regulator Applications

- Low drain-source ON resistance: $RDS(ON) = 1.0 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 7.0 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A (max) (V_{DS} = 720 \ V)$
- Enhancement model: $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ID} = 1 \text{ mA})$

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Characteristic			Symbol	Rating	Unit			
Drain-source voltage			V _{DSS}	900	V			
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V _{DGR}	900	V			
Gate-source voltage			V _{GSS}	±30	V			
Drain current	DC (N	lote 1)	Ι _D	9	А			
	Pulse (N	lote 1)	I _{DP}	27	A			
Drain power dissipation (Tc = 25° C)			PD	150	W			
Single pulse avalanche energy (Note 2)			E _{AS}	778	mJ			
Avalanche current			I _{AR}	9	А			
Repetitive avalanche energy (Note 3)			E _{AR}	15	mJ			
Channel temperature			T _{ch}	150	°C			
Storage temperature range			T _{stg}	-55~150	°C			





Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

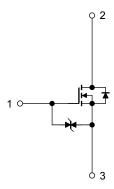
Characteristic	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	0.833	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

Note 2: $V_{DD} = 90 \text{ V}, \text{ } T_{ch} = 25^{\circ}\text{C}, \text{ } L = 17.6 \text{ } \text{mH}, \text{ } \text{R}_{G} = 25 \Omega, \text{ } \text{I}_{AR} = 9 \text{ } \text{A}$

Note 3: Repetitive rating: pulse width limited by max junction temperature

This transistor is an electrostatic-sensitive device. Handle with care.



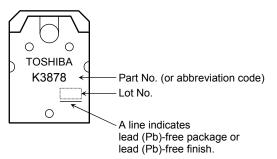
Electrical Characteristics (Ta = 25°C)

Char	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm30~V,~V_{DS}=0~V$	_		±10	μA
Drain-source brea	akdown voltage	V _(BR) GSS	$I_G=\pm 10~\mu A,~V_{DS}=0~V$	±30		_	V
Drain cutoff curre	ent	I _{DSS}	$V_{DS} = 720 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	_	100	μA
Drain-source brea	akdown voltage	V (BR) DSS	$I_D=10\ mA,\ V_{GS}=0\ V$	900			V
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0	_	4.0	V
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS}=10~V,~I_D=4~A$	_	1.0	1.3	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS}=15~V,~I_D=4~A$	3.5	7.0	_	S
Input capacitance		C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		2200		pF
Reverse transfer capacitance		C _{rss}			45	_	
Output capacitance		C _{oss}		_	190		
Switching time	Rise time	tr	$\begin{array}{c} 10 \text{ V} \\ \text{V}_{GS} \\ 0 \text{ V} \\ \hline \\ \hline \\ \hline \\ \\ \\ \hline \\ \\ \\ \\ \hline \\ \\ \\ \hline \\ \\ \\ \\ \hline \\ \\ \\ \hline \\ \\ \\ \\ \hline \\ \\ \\ \\ \\ \hline \\ \\ \\ \\ \\ \hline \\$		25		ns
	Turn-on time	t _{on}			65		
	Fall time	t _f			20		
	Turn-off time	t _{off}			120	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 9 \text{ A}$		60		nC
Gate-source charge		Q _{gs}		—	34	_	
Gate-drain ("Miller") charge		Q _{gd}			26		

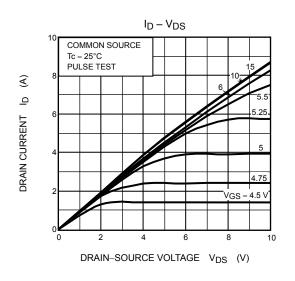
Source-Drain Ratings and Characteristics (Ta = 25°C)

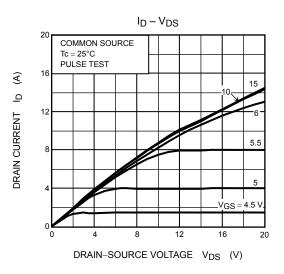
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	9	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	27	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 9 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 9 A, V _{GS} = 0 V,	_	1.4	_	μS
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs		16		μC

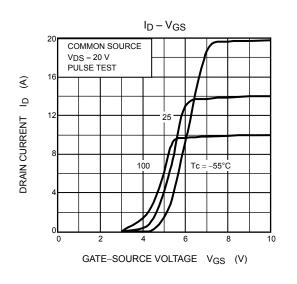
Marking

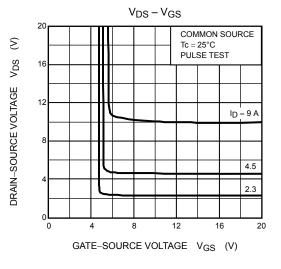


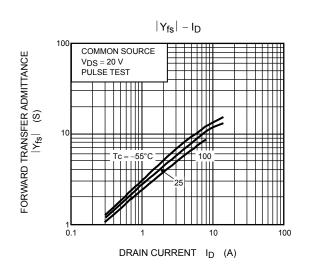
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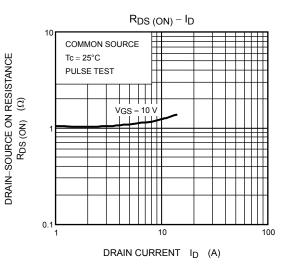




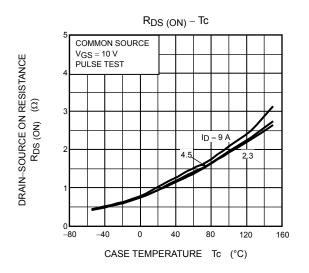


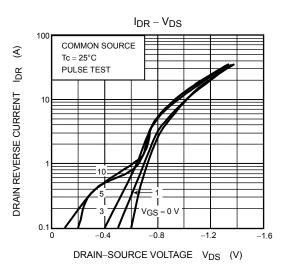


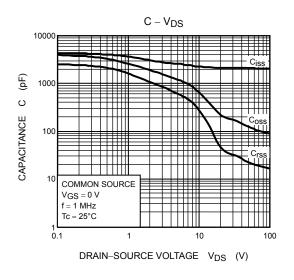


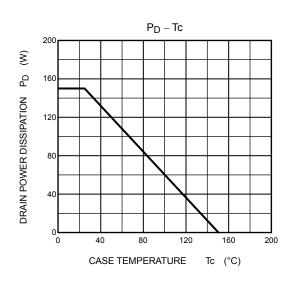


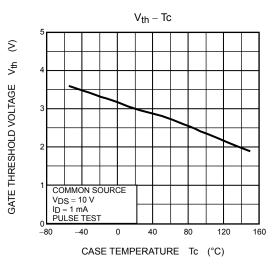
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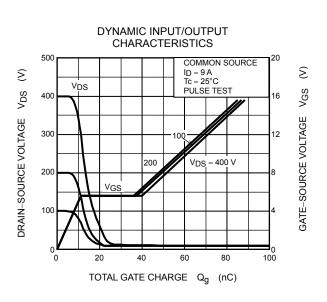


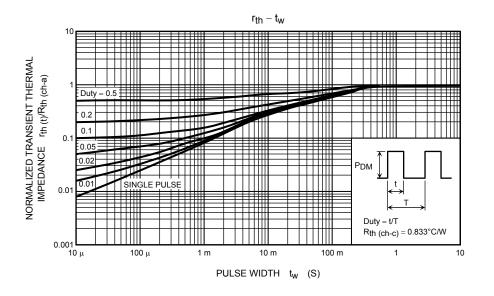




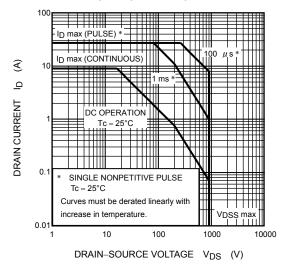


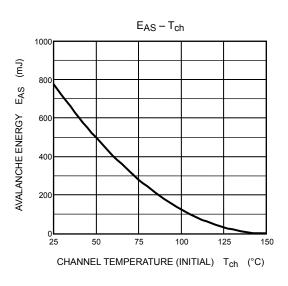


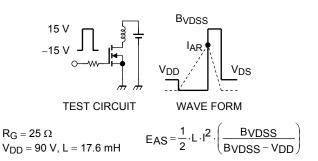




SAFE OPERATING AREA







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